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# R8C/13 Group SINGLE-CHIP 16-BIT CMOS MICROCOMPUTER

REJ03B0069-0120 Rev.1.20 Jan 27, 2006

### 1. Overview

This MCU is built using the high-performance silicon gate CMOS process using a R8C/Tiny Series CPU core and is packaged in a 32-pin plastic molded LQFP. This MCU operates using sophisticated instructions featuring a high level of instruction efficiency. With 1M bytes of address space, it is capable of executing instructions at high speed.

The data flash ROM (2 KB X 2 blocks) is embedded.

### 1.1 Applications

Electric household appliance, office equipment, housing equipment (sensor, security), general industrial equipment, audio, etc.

### 1.2 Performance Overview

Table 1.1. lists the performance outline of this MCU.

**Table 1.1 Performance outline** 

	Item	Performance
CPU	Number of basic instructions	89 instructions
	Minimum instruction execution time	50 ns (f(XIN) = 20 MHz, VCC = 3.0 to 5.5 V)
		100 ns (f(XIN) = 10 MHz, VCC = 2.7 to 5.5 V)
	Operating mode	Single-chip
	Address space	1M bytes
	Memory capacity	See Table 1.2.
Peripheral	Port	Input/Output: 22 (including LED drive port), Input: 2
function	LED drive port	I/O port: 8
,	Timer	Timer X: 8 bits x 1 channel, Timer Y: 8 bits x 1 channel,
		Timer Z: 8 bits x 1 channel
		(Each timer equipped with 8-bit prescaler)
		Timer C: 16 bits x 1 channel
		(Circuits of input capture and output compare)
	Serial interface	•1 channel
		Clock synchronous, UART
		•1 channel
		UART
,	A/D converter	10-bit A/D converter: 1 circuit, 12 channels
	Watchdog timer	15 bits x 1 (with prescaler)
		Reset start function selectable
	Interrupt	Internal: 11 factors, External: 5 factors,
		Software: 4 factors, Priority level: 7 levels
	Clock generation circuit	2 circuits
		•Main clock generation circuit (Equipped with a built-in
		feedback resistor)
		On-chip oscillator (high-speed, low-speed)
		On high-speed on-chip oscillator the frequency adjust-
		ment function is usable.
	Oscillation stop detection function	Main clock oscillation stop detection function
	Voltage detection circuit	Included
	Power on reset circuit	Included
Electrical	Supply voltage	VCC = 3.0  to  5.5V (f(XIN) = 20MHz)
characteristics		VCC = 2.7  to  5.5V (f(XIN) = 10MHz)
	Power consumption	Typ.9 mA ( $VCC = 5.0V$ , ( $f(XIN) = 20MHz$ )
		Typ.5 mA ( $VCC = 3.0V$ , ( $f(XIN) = 10MHz$ )
		Typ.35 $\mu$ A (VCC = 3.0V, Wait mode, Peripheral clock stops)
		Typ.0.7 $\mu$ A (VCC = 3.0V, Stop mode)
Flash memory	Program/erase supply voltage	VCC = 2.7 to 5.5 V
	Program/erase endurance	10,000 times (Data flash)
		1,000 times (Program ROM)
Operating amb	pient temperature	-20 to 85°C
		-40 to 85°C (D-version)
Package		32-pin plastic mold LQFP

### 1.3 Block Diagram

Figure 1.1 shows this MCU block diagram.

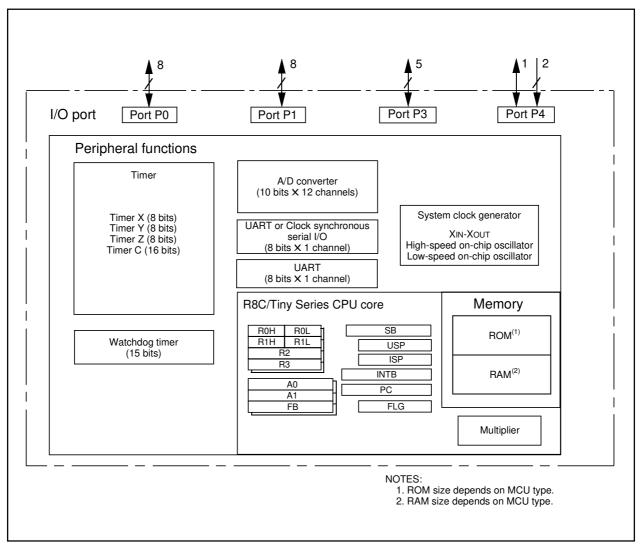


Figure 1.1 Block Diagram

### 1.4 Product Information

Table 1.2 lists the product information.

**Table 1.2 Product Information** 

			0000
As	O١،	January	2006

			710 01 dandary 2000		
Type No.	ROM Program ROM	capacity  Data flash	RAM capacity	Package type	Remarks
R5F21132FP	8K bytes	2K bytes x 2	512 bytes	PLQP0032GB-A	Flash memory version
R5F21133FP	12K bytes	2K bytes x 2	768 bytes	PLQP0032GB-A	
R5F21134FP	16K bytes	2K bytes x 2	1K bytes	PLQP0032GB-A	
R5F21132DFP	8K bytes	2K bytes x 2	512 bytes	PLQP0032GB-A	D version
R5F21133DFP	12K bytes	2K bytes x 2	768 bytes	PLQP0032GB-A	
R5F21134DFP	16K bytes	2K bytes x 2	1K bytes	PLQP0032GB-A	

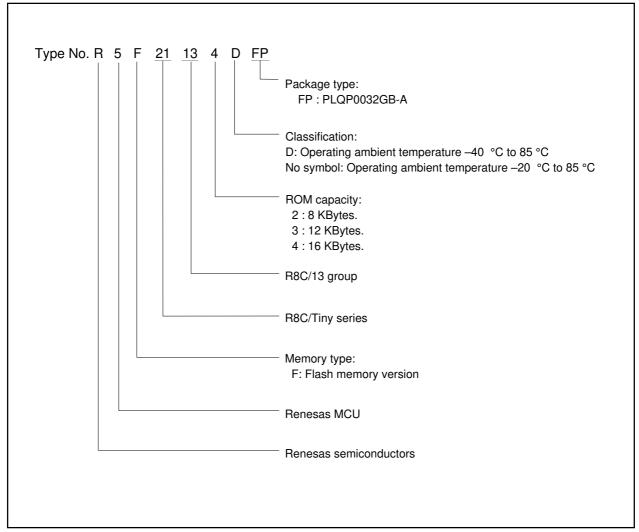


Figure 1.2 Type No., Memory Size, and Package

### 1.5 Pin Assignments

Figure 1.3 shows the pin configuration (top view).

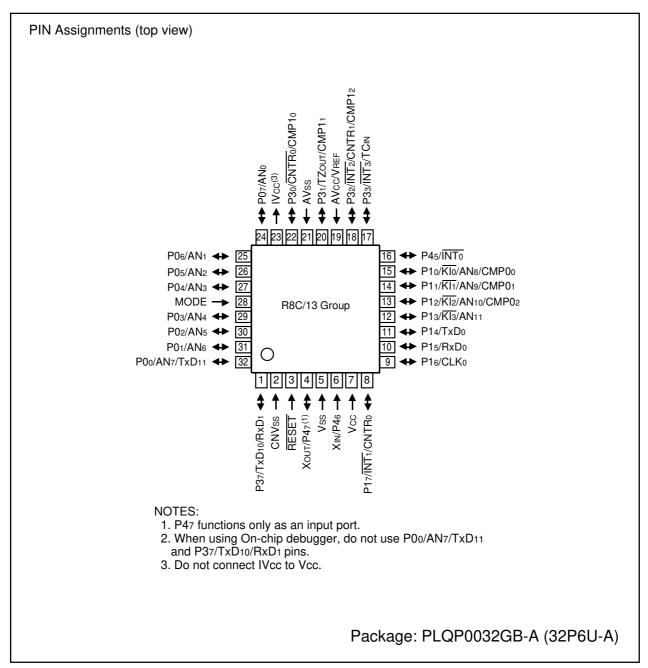


Figure 1.3 Pin Assignments (Top View)

### 1.6 Pin Description

Table 1.3 shows the pin description

Table 1.3 Pin description

Signal name	Pin name	I/O type	Function
Power supply	Vcc,	I	Apply 2.7 V to 5.5 V to the Vcc pin. Apply 0 V to the
input	Vss		Vss pin.
IVcc	IVcc	0	This pin is to stabilize internal power supply.
			Connect this pin to Vss via a capacitor (0.1 μF).
			Do not connect to Vcc.
Analog power	AVcc, AVss	I	Power supply input pins for A/D converter. Connect the
supply input			AVcc pin to Vcc. Connect the AVss pin to Vss. Connect a
			capacitor between pins AVcc and AVss.
Reset input	RESET	I	Input "L" on this pin resets the MCU.
CNVss	CNVss	I	Connect this pin to Vss via a resistor.
MODE	MODE	I	Connect this pin to Vcc via a resistor.
Main clock input	XIN	I	These pins are provided for the main clock generat-
			ing circuit I/O. Connect a ceramic resonator or a crys-
Main clock output	Xout	0	tal oscillator between the XIN and XOUT pins. To use
			an externally derived clock, input it to the XIN pin and
			leave the XOUT pin open.
INT interrupt input	INTo to INT3	1	INT interrupt input pins.
Key input interrupt	Klo to Kla	I	Key input interrupt pins.
input			
Timer X	CNTR <sub>0</sub>	I/O	Timer X I/O pin
	CNTR <sub>0</sub>	0	Timer X output pin
Timer Y	CNTR <sub>1</sub>	I/O	Timer Y I/O pin
Timer Z	TZout	0	Timer Z output pin
Timer C	TCIN	I	Timer C input pin
	CMP00 to CMP02,	0	The timer C output pins
	CMP10 to CMP12		
Serial interface	CLK <sub>0</sub>	I/O	Transfer clock I/O pin.
	RxD0, RxD1	I	Serial data input pins.
	TxD0, TxD10,	0	Serial data output pins.
	TxD11		
Reference voltage	VREF	I	Reference voltage input pin for A/D converter. Con-
input			nect the VREF pin to Vcc.
A/D converter	ANo to AN11	I	Analog input pins for A/D converter
I/O port	P00 to P07,	I/O	These are 8-bit CMOS I/O ports. Each port has an I/O
	P10 to P17,		select direction register, allowing each pin in that port
	P30 to P33, P37,		to be directed for input or output individually.
	P45		Any port set to input can select whether to use a pull-
			up resistor or not by program.
			P10 to P17 also function as LED drive ports.
Input port	P46, P47	I	Port for input-only

### 2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU Register. The CPU contains 13 registers. Of these, R0, R1, R2, R3, A0, A1 and FB comprise a register bank. Two sets of register banks are provided.

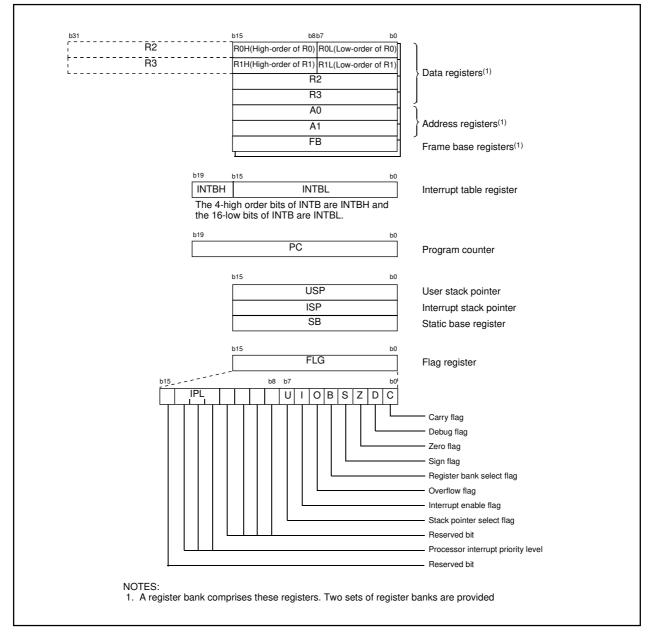


Figure 2.1 CPU Register

### 2.1 Data Registers (R0, R1, R2 and R3)

R0 is a 16-bit register for transfer, arithmetic and logic operations. The same applies to R1 to R3. The R0 can be split into high-order bit (R0H) and low-order bit (R0L) to be used separately as 8-bit data registers. The same applies to R1H and R1L as R0H and R0L. R2 can be combined with R0 to be used as a 32-bit data register (R2R0). The same applies to R3R1 as R2R0.

### 2.2 Address Registers (A0 and A1)

A0 is a 16-bit register for address register indirect addressing and address register relative addressing. They also are used for transfer, arithmetic and logic operations. The same applies to A1 as A0. A0 can be combined with A0 to be used as a 32-bit address register (A1A0).

### 2.3 Frame Base Register (FB)

FB is a 16-bit register for FB relative addressing.

### 2.4 Interrupt Table Register (INTB)

INTB is a 20-bit register indicates the start address of an interrupt vector table.

### 2.5 Program Counter (PC)

PC, 20 bits wide, indicates the address of an instruction to be executed.

### 2.6 User Stack Pointer (USP) and Interrupt Stack Pointer (ISP)

The stack pointer (SP), USP and ISP, are 16 bits wide each.

The U flag of FLG is used to switch between USP and ISP.

### 2.7 Static Base Register (SB)

SB is a 16-bit register for SB relative addressing.

### 2.8 Flag Register (FLG)

FLG is a 11-bit register indicating the CPU state.

### 2.8.1 Carry Flag (C)

The C flag retains a carry, borrow, or shift-out bit that has occurred in the arithmetic logic unit.

### 2.8.2 Debug Flag (D)

The D flag is for debug only. Set to "0".

### 2.8.3 Zero Flag (Z)

The Z flag is set to "1" when an arithmetic operation resulted in 0; otherwise, "0".

### 2.8.4 Sign Flag (S)

The S flag is set to "1" when an arithmetic operation resulted in a negative value; otherwise, "0".

### 2.8.5 Register Bank Select Flag (B)

The register bank 0 is selected when the B flag is "0". The register bank 1 is selected when this flag is set to "1".

### 2.8.6 Overflow Flag (O)

The O flag is set to "1" when the operation resulted in an overflow; otherwise, "0".

### 2.8.7 Interrupt Enable Flag (I)

The I flag enables a maskable interrupt.

An interrupt is disabled when the I flag is set to "0", and are enabled when the I flag is set to "1". The I flag is set to "0" when an interrupt request is acknowledged.

### 2.8.8 Stack Pointer Select Flag (U)

ISP is selected when the U flag is set to "0", USP is selected when the U flag is set to "1".

The U flag is set to "0" when a hardware interrupt request is acknowledged or the INT instruction of software interrupt numbers 0 to 31 is executed.

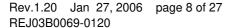
### 2.8.9 Processor Interrupt Priority Level (IPL)

IPL, 3 bits wide, assigns processor interrupt priority levels from level 0 to level 7.

If a requested interrupt has greater priority than IPL, the interrupt is enabled.

### 2.8.10 Reserved Bit

When write to this bit, set to "0". When read, its content is indeterminate.





R8C/13 Group 3. Memory

### 3. Memory

Figure 3.1 is a memory map of this MCU. This MCU provides 1-Mbyte address space from addresses 0000016 to FFFFF16.

The internal ROM (program ROM) is allocated lower addresses beginning with address 0FFFF16. For example, a 16-Kbyte internal ROM is allocated addresses from 0C00016 to 0FFFF16.

The fixed interrupt vector table is allocated addresses 0FFDC16 to 0FFFF16. They store the starting address of each interrupt routine.

The internal ROM (data flash) is allocated addresses from 0200016 to 02FFF16.

The internal RAM is allocated higher addresses beginning with address 0040016. For example, a 1-Kbyte internal RAM is allocated addresses 0040016 to 007FF16. The internal RAM is used not only for storing data, but for calling subroutines and stacks when interrupt request is acknowledged.

Special function registers (SFR) are allocated addresses 0000016 to 002FF16. The peripheral function control registers are located them. All addresses, which have nothing allocated within the SFR, are reserved area and cannot be accessed by users.

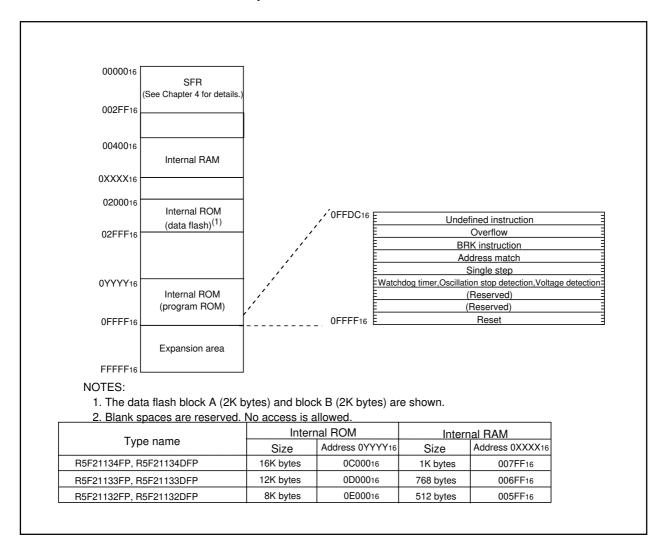


Figure 3.1 Memory Map

## 4. Special Function Register (SFR)

SFR(Special Function Register) is the control register of peripheral functions. Tables 4.1 to 4.4 list the SFR information

Table 4.1 SFR Information(1)<sup>(1)</sup>

Address	Register	Symbol	After reset
000016	•		
000116			
000216			
000316			
000416	Processor mode register 0 <sup>(1)</sup>	PM0	0016
000516	Processor mode register 1	PM1	0016
000616	System clock control register 0	CM0	011010002
000716	System clock control register 1	CM1	001000002
000816	High-speed on-chip oscillator control register 0	HR0	0016
000916	Address match interrupt enable register	AIER	XXXXXX002
000A16	Protect register	PRCR	00XXX0002
000B16	High-speed on-chip oscillator control register 1	HR1	4016
000C16	Oscillation stop detection register	OCD	000001002
000D16	Watchdog timer reset register	WDTR	XX16
000E16	Watchdog timer start register	WDTS	XX16
000F16	Watchdog timer control register	WDC	000111112
001016	Address match interrupt register 0	RMAD0	0016
001116	, ,		0016
001216			X016
001316			
001416	Address match interrupt register 1	RMAD1	0016
001516			0016
001616			X016
001716			
001816			
001916	Voltage detection register 1 <sup>(2)</sup>	VCR1	000010002
001A <sub>16</sub>	Voltage detection register 2 <sup>(2)</sup>	VCR2	0016 <sup>(3)</sup>
			100000002 <sup>(4)</sup>
001B <sub>16</sub>			
001C <sub>16</sub>			
001D16			
001E <sub>16</sub>	INTO input filter select register	INT0F	XXXXX0002
001F <sub>16</sub>	Voltage detection interrupt register <sup>(2)</sup>	D4INT	0016 <sup>(3)</sup>
			010000012 <sup>(4)</sup>
002016			
002116			
002216			
002316			
002416			
002516			
002516 002616			
002516 002616 002716			
002516 002616 002716 002816			
002516 002616 002716 002816 002916			
002516 002616 002716 002816 002916 002A16			
002516 002616 002716 002816 002916 002A16 002B16			
002516 002616 002716 002816 002916 002A16 002B16			
002516 002616 002716 002816 002916 002A16 002B16 002C16 002D16			
002516 002616 002616 002716 002816 002916 002A16 002B16 002C16 002D16			
002516 002616 002716 002816 002916 002A16 002B16 002C16 002D16 002E16 002F16			
002516 002616 002716 002816 002916 002A16 002B16 002C16 002D16 002F16 003016			
002516 002616 002716 002816 002916 002A16 002B16 002C16 002D16 002E16 002F16 003016 003116			
002516 002616 002716 002816 002916 002A16 002B16 002C16 002D16 002F16 002F16 003116			
002516 002616 002716 002816 002916 002A16 002B16 002C16 002D16 002F16 003116 003216 00316			
002516 002616 002716 002816 002916 002816 002016 002D16 002D16 002D16 002F16 003016 003116 003316 003316			
002516 002616 002716 002816 002916 002816 002C16 002D16 002D16 002E16 002F16 00316 00316 003316 003416 003516			
002516 002616 002716 002816 002916 002816 002D16 002D16 002D16 002D16 002D16 003016 00316 003316 003316 003316 003516			
002516 002616 002716 002818 002916 002216 002D16 002D16 002D16 002E16 002F16 00316 00316 003316 003316 003516 003516			
002516 002616 002716 002816 002916 002D16 002D16 002D16 002D16 002D16 003116 003116 003316 003316 003316 003316 003516 003516 003516			
002516 002616 002716 002816 002916 002216 002D16 002D16 002D16 002D16 003D16 003016 003116 003316 003516 003516 003616 003716			
002516 002616 002716 002816 002916 002216 002D16 002D16 002E16 002E16 003D16 003116 00316 003516 003516 003716 003716 003716			
002516 002616 002716 002816 002916 002216 002D16 002D16 002E16 002E16 002E16 003216 00316 003516 003516 003616 003716 003716 003716 003816			
002516 002616 002716 002816 002916 002816 002216 002D16 002D16 002E16 002E16 003E16 00316 00316 003516 003616 003716 003816 003816 003816 003816 003816			
002516 002616 002716 002818 002916 002216 002D16 002D16 002D16 002E18 003D16 003116 003316 003316 003516 003616 003718 003616 003718 003916 003916 003916 003916			
002516 002616 002716 002816 002916 002816 002216 002D16 002D16 002E16 002E16 003E16 00316 00316 003516 003616 003716 003816 003816 003816 003816 003816			

X : Undefined

X: Underined
NOTES:

1. Blank spaces are reserved. No access is allowed.

2. Software reset or the watchdog timer reset does not affect this register.

3. Owing to Reset input.

4. In the case of RESET pin = H retaining.

Table 4.2 SFR Information(2)<sup>(1)</sup>

	4.2 Of It information(2)		
Address	Register	Symbol	After reset
004016	9.0.0.		
004116			
004216			
004316			
004416			
004516			
004616			
004716			
004816			
004916			-
004A16			
004B <sub>16</sub>			
004C16			
004D16	Key input interrupt control register	KUPIC	XXXXX0002
004E16	AD conversion interrupt control register	ADIC	XXXXX0002
004F16	· · · · · · · · · · · · · · · · · · ·		
005016	Compare 1 interrupt control register	CMP1IC	XXXXX0002
005116	UART0 transmit interrupt control register	SOTIC	XXXXXX0002
005116			•
	UART0 receive interrupt control register	S0RIC	XXXXX0002
005316	UART1 transmit interrupt control register	S1TIC	XXXXX0002
005416	UART1 receive interrupt control register	S1RIC	XXXXX0002
005516	INT2 interrupt control register	INT2IC	XXXXX0002
005616	Timer X interrupt control register	TXIC	XXXXX0002
005716	Timer Y interrupt control register	TYIC	XXXXX0002
005816	Timer Z interrupt control register	TZIC	XXXXX0002
005916	INT1 interrupt control register	INT1IC	XXXXX0002
005516 005A16	INT3 interrupt control register	INT3IC	XXXXX0002 XXXXX0002
005A16	Timer C interrupt control register	TCIC	XXXXX0002 XXXXXX0002
005C16	Compare 0 interrupt control register	CMP0IC	XXXXX0002
005D16	INTO interrupt control register	INT0IC	XX00X0002
005E16			
005F16			
006016			
006116			
006216			-
006316			
006416			
006516			
006616			
006716			
006816			
006916			
006A16			1
006A16			+
006C16			
006D16			
006E16			
006F16			
007016			
007116			
007216			†
007216			+
			1
007416			
007516			
007616			
007716			
007816			
007916			
007A16			
007H16			+
			-
007C16			
007D16			
007E16			
007F16			

X : Undefined NOTES:
1. Blank spaces are reserved. No access is allowed.

### Table 4.3 SFR Information(3)<sup>(1)</sup>

	Address	Register	Symbol	After reset
Prescaler / register   PREY   FF16		<del>-</del>	-	
				-
Doeses		Timer Y. 7 waveform output control register		
100874				
10087-1		Timer Z secondary register		
10089s   1				
Timer X mode register		Timer Y 7 output control register	TYZOC	0016
Prescaler X register				
Timer X register				
Count source set register				
Timer C register				
Timer C register   TC		Oddin oddioo od rogiotor	1000	00.0
003916   0		Timer C register	TC	0016
000816   0		Timer o register	10	
009316   009416   009516   External input enable register				0010
009516				
D09516   External input enable register				
D009716   Key input enable register				
0097/6   Key input enable register		External input enable register	INITENI	0016
D009916		External input enable register	IIN I LIN	0010
009916		Key input enable register	KIEN	0016
DOBA16		rey input chable register	KILIN	0010
Timer C control register 1		Timer C control register 0	TCC0	0016
Capture, compare 0 register				
009D16   009F16   009F16   009F16   009F16   009F16   009F16   009F16   009F16   009F16   009D16   009F16   009D16   0				
Compare 1 register		Capture, compare o register	TIVIO	
009Fis   00A010   UART0 transmit/receive mode register   U0MR   0016   00A110   UART0 bit rate register   U0MR   0016   00A110   UART0 bit rate register   U0MR   XX16   XX16   00A210   UART0 transmit buffer register   U0TB   XX16   UART0 transmit/receive control register 0   U0C0   000010002   00A510   UART0 transmit/receive control register 1   U0C1   000000102   U0RB   XX16   U0AT0   U0AT1   U0AT1   U0AT1   U0AT1   U0AT1   U0AT1   U1AT1   U1AT		Compare 1 register	TNA	
UART0 transmit/receive mode register		Compare i register	I IVI I	
UART0 bit rate register   UOBRG   XX16		LIARTO transmit/raceive mode register	LIOMB	
UART0 transmit buffer register				
00A316				
UART0 transmit/receive control register 0	1	OARTO transmit buller register	UUIB	
OA516		LIADTO transmit/receive control register 0	LIOCO	
UART1 transmit/receive buffer register				
00A716				
O0A816		OARTO Teceive bullet register	OUND	
O0A916		IIART1 transmit/receive mode register	HIMR	
00AA16 00AB16         UART1 transmit buffer register         U1TB         XX16 XX16           00AC16         UART1 transmit/receive control register 0         U1C0         000010002           00AD16         UART1 transmit/receive control register 1         U1C1         000000102           00AE16 00AF16         UART1 receive buffer register         U1RB         XX16 XX16           00B016         UART transmit/receive control register 2         UCON         0016           00B116         00B216         00B316           00B416         00B416         00B416           00B716         00B416         00B416           00B316         00B416         00B416           00B316         00B416         00B416           00B416         00B416         00B416				
00AB16         XX16           00AC16         UART1 transmit/receive control register 0         U1C0         000010002           00AD16         UART1 transmit/receive control register 1         U1C1         000000102           00AE16         UART1 receive buffer register         U1RB         XX16           00B016         UART transmit/receive control register 2         UCON         0016           00B16         00B16         00B16           00B516         00B616         00B616           00B716         00B616         00B616           00B616         00B616         00B616				
00AC16         UART1 transmit/receive control register 0         U1C0         000010002           00AD16         UART1 transmit/receive control register 1         U1C1         000000102           00AE16         UART1 receive buffer register         U1RB         XX16           00B016         UART transmit/receive control register 2         UCON         0016           00B16         00B16         00B16           00B216         00B216         00B216           00B316         00B316         00B316		UAD I I transmit buller register	UIIB	
00AD16         UART1 transmit/receive control register 1         U1C1         000000102           00AE16 00AF16         UART1 receive buffer register         U1RB         XX16           00B016         UART transmit/receive control register 2         UCON         0016           00B116         00B216         00B316         00B316           00B316         00B316         00B316         00B316           00B316         00B316         00B316         00B316           00B316         00B316         00B316         00B316         00B316           00B316 <t< td=""><td></td><td>IIART1 transmit/receive control register 0</td><td>LIICO</td><td>00010002</td></t<>		IIART1 transmit/receive control register 0	LIICO	00010002
00AE16 00AF16         UART1 receive buffer register         U1RB         XX16 XX16           00B016 00B116         UART transmit/receive control register 2         UCON         0016           00B216 00B316 00B416         0080000000000000000000000000000000000				
00AF16         XX16           00B016         UART transmit/receive control register 2         UCON         0016           00B116         008216         008316		<u> </u>		
00B016         UART transmit/receive control register 2         UCON         0016           00B116             00B216             00B316             00B516             00B616             00B716             00B816             00B816             00B16             00BC16             00BD16             00BE16		Onter i receive buller register	UIID	
00B116       00B216       00B316       00B416       00B516       00B616       00B716       00B816       00B916       00B416       00B416       00B16       00B16       00B16       00B16       00B16       00B16       00B16       00B16		IJART transmit/receive control register 2	LICON	
008216         008316         008416         008516         008616         008716         008816         008916         008416         008416         00816         00816         00816         00816         00816         00816         00816         00816		Oracli transmitreceive control register 2	00011	3010
00B316       00B416         00B516       00B616         00B716       00B816         00B916       00B916         00B416       00B816         00B16       00B16         00B16       00B16         00B16       00B16         00B16       00B16				
00B416       00B516         00B616       00B716         00B816       00B816         00B916       00BA16         00BB16       00BC16         00BD16       00BD16         00BE16       00BE16				
008516       008616       008716       008816       008916       008A16       008B16       00BC16       00BD16       00BE16				
008616       008716       008816       008916       008A16       008B16       00BC16       00BD16       00BE16				
00B716       00B816       00B916       00BA16       00BB16       00BC16       00BD16       00BE16				
008816       008916       00BA16       00BB16       00BC16       00BD16       00BE16				
00B916       00BA16       00BB16       00BC16       00BD16       00BE16				
00BA16         00BB16           00BC16         00BD16           00BE16         00BE16				
00BB16       00BC16       00BD16       00BE16				
00BC16         00BD16           00BE16         00BE16				
00BD16 00BE16 00BE16				
00BE16				
OURL16				
	00BF16			

X: Undefined
NOTES:

1. Blank spaces are reserved. No access is allowed.

2. When output compare mode (the TCC13 bit in the TCC1 register = 1) is selected, the value after reset is set to "FFFF16".

### Table 4.4 SFR Information(4)<sup>(1)</sup>

Address	Register	Symbol	After reset
00C016	AD register	AD	XX16
00C116			XX16
00C216 00C316			
00C416			
00C516			
00C616			
00C716			
00C816 00C916			
00C916			
00CB16			
00CC16			
00CD16			
00CE16			
00CF16 00D016			
00D116			
00D216			
00D316			
00D416	AD control register 2	ADCON2	0016
00D516 00D616	AD control register 0	ADCON0	00000XXX2
00D616 00D716	AD control register 1	ADCON0	0016
00D816			7-1-
00D916			
00DA16			
00DB16			
00DC16 00DD16			
00DE16			
00DF16			
00E016	Port P0 register	P0	XX16
00E116	Port P1 register	P1	XX16
00E216 00E316	Port P0 direction register	PD0	0016
00E316	Port P1 direction register	PD1	0016
00E516	Port P3 register	P3	XX16
00E616			-
00E716	Port P3 direction register	PD3	0016
00E816	Port P4 register	P4	XX16
00E916 00EA16	Port P4 direction register	PD4	0016
00EB16	Torra direction register	1 04	0010
00EC16			
00ED16			
00EE16			
00EF16			
00F016 00F116			
00F116			
00F316			
00F416			
00F516			
00F616			
00F7 <sub>16</sub>			
00F916			
03FA <sub>16</sub>			
00FB16			
00FC16	Pull-up control register 0	PUR0	00XX00002
00FD16 00FE16	Pull-up control register 1 Port P1 drive capacity control register	PUR1 DRR	XXXXXX0X2 0016
00FE16	Timer C output control register	TCOUT	0016
‱			
01B3 <sub>16</sub>	Flash memory control register 4	FMR4	010000002
01B416	Elach mamory control register 1	EMD1	1000000
01B516 01B616	Flash memory control register 1	FMR1	1000000X2
01B616	Flash memory control register 0	FMR0	000000012
	· · · · · · · · · · · · · · · · · · ·	1	
0FFFF16	Option function select register <sup>(2)</sup>	OFS	(Note 2)

X: Undefined
NOTES:

1. Blank columns, 010016 to 01B216 and 01B816 to 02FF16 are all reserved. No access is allowed.

2. The watchdog timer control bit is assigned. Refer to "Figure11.2 OFS, WDC, WDTR and WDTS registers" of Hardware Manual for details

### 5. Electrical Characteristics

**Table 5.1 Absolute Maximum Ratings** 

Symbol	Parameter	Condition	Rated value	Unit
Vcc	Supply voltage	Vcc=AVcc	-0.3 to 6.5	٧
AVcc	Analog supply voltage	Vcc=AVcc	-0.3 to 6.5	٧
Vı	Input voltage		-0.3 to Vcc+0.3	٧
Vo	Output voltage		-0.3 to Vcc+0.3	٧
Pd	Power dissipation	Topr=25 °C	300	mW
Topr	Operating ambient temperature		-20 to 85 / -40 to 85 (D version)	°C
Tstg	Storage temperature		-65 to 150	°C

**Table 5.2 Recommended Operating Conditions** 

0	Parameter		Conditions		Standard			
Symbol			Conditions	Min.	Тур.	Max.	Unit	
Vcc	Supply voltage			2.7		5.5	V	
AVcc	Analog supply v	roltage			VCC(3)		V	
Vss	Supply voltage				0		V	
AVss	Analog supply v	roltage			0		V	
VIH	"H" input voltag	е		0.8Vcc		Vcc	V	
VIL	"L" input voltage	е		0		0.2Vcc	V	
I <sub>OH (sum)</sub>	"H" peak all output currents	Sum of all pins' IOH (peak)				-60.0	mA	
I <sub>OH</sub> (peak)	"H" peak output current					-10.0	mA	
I <sub>OH (avg)</sub>	"H" average out	out current		_		-5.0	mA	
I <sub>OL (sum)</sub>	"L" peak all output currents	Sum of all pins' IOL (peak)		_		60	mA	
I <sub>OL (peak)</sub>	"L" peak output	Except P10 to P17				10	mA	
	current	P10 to P17	Drive ability HIGH			30	mA	
			Drive ability LOW	_		10	mA	
I <sub>OL (avg)</sub>	"L" average	Except P10 to P17				5	mA	
· OL (avg)	output current	P10 to P17	Drive ability HIGH			15	mA	
			Drive ability LOW			5	mA	
f (XIN)	Main clock inpu	t oscillation frequency	3.0V ≤ Vcc ≤ 5.5V	0		20	MHz	
			2.7V ≤ Vcc < 3.0V	0		10	MHz	

<sup>1.</sup> Vcc = AVcc = 2.7 to 5.5V at Topr = -20 to 85 °C / -40 to 85 °C, unless otherwise specified.
2. The typical values when average output current is 100ms.
3. Hold Vcc=AVcc.

**Table 5.3 A/D Conversion Characteristics** 

Cumphal	Dovo	Parameter		Managerian	Standard			Unit
Symbol	Para	imeter		Measuring condition	Min.	Тур.	Max.	Onit
_	Resolution			Vref =VCC	_	_	10	Bit
_	Absolute	10 1	oit mode	øAD=10 MHz, Vref=Vcc=5.0V	_	_	±3	LSB
	accuracy	8 1	oit mode	øAD=10 MHz, Vref=Vcc=5.0V		_	±2	LSB
		10 l	oit mode	øAD=10 MHz, Vref=Vcc=3.3V(3)	_		±5	LSB
		8 k	oit mode	øAD=10 MHz, Vref=Vcc=3.3V(3)	_	_	±2	LSB
RLADDER	Ladder resistance			VREF=VCC	10	_	40	kΩ
tconv	Conversion time		10 bit mode	øAD=10 MHz, Vref=Vcc=5.0V	3.3		-	μs
			8 bit mode	øAD=10 MHz, Vref=Vcc=5.0V	2.8		_	μs
VREF	Reference voltage	Reference voltage				V <sub>CC</sub> <sup>(4)</sup>	_	V
VIA	Analog input voltage			0		Vref	٧	
_	A/D operating	Without s	ample & hold		0.25	_	10	MHz
	clock frequency(2)	With sar	nple & hold		1.0		10	MHz

- Vcc=AVcc=2.7 to 5.5V at Topr = -20 to 85 °C / -40 to 85 °C, unless otherwise specified.
   If fAD exceeds 10 MHz more, divide the fAD and hold A/D operating clock frequency (ØAD) 10 MHz or below.
   If the AVcc is less than 4.2V, divide the fAD and hold A/D operating clock frequency (ØAD) fAD/2 or below.
   Hold Vcc=Vref.

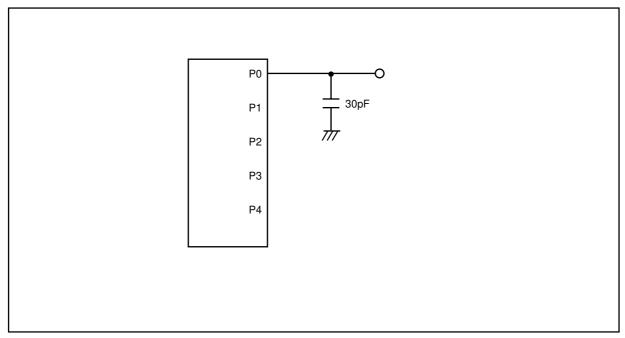


Figure 5.1 Port P0 to P4 measurement circuit

Table 5.4 Flash Memory (Program ROM) Electrical Characteristics

Symbol	Parameter	Measuring condition				
Cymbol	Parameter	Measuring condition	Min.	Тур.	Max	Unit
_	Program/Erase endurance <sup>(2)</sup>		1000(3)	_	_	times
_	Byte program time			50	_	μs
_	Block erase time		_	0.4	<u> </u>	S
td(SR-ES)	Time delay from Suspend Request until Erase Suspend			_	8	ms
_	Erase Suspend Request Interval		10	_		ms
_	Program, Erase Voltage		2.7		5.5	V
_	Read Voltage		2.7	_	5.5	٧
_	Program, Erase Temperature		0	_	60	°C
_	Data hold time <sup>(7)</sup>	Ambient temperature = 55 °C	20			year

#### NOTES:

- 1. Referenced to Vcc=AVcc=2.7 to 5.5V at Topr = 0°C to 60°C unless otherwise specified.
- 2. Definition of Program/Erase

The endurance of Program/Erase shows a time for each block.

If the program/erase number is "n" (n = 1000, 10000), "n" times erase can be performed for each block.

For example, if performing one-byte write to the distinct addresses on Block A of 2K-byte block 2048 times and then erasing that block, the number of Program/Erase cycles is one time.

However, performing multiple writes to the same address before an erase operation is prohibited (overwriting prohibited).

- 3. Numbers of Program/Erase cycles for which all electrical characteristics is guaranteed.
- 4. To reduce the number of Program/Erase cycles, a block erase should ideally be performed after writing in series as many distinct addresses (only one time each) as possible. If programming a set of 16 bytes, write up to 128 sets and then erase them one time. This will result in ideally reducing the number of Program/Erase cycles. Additionally, averaging the number of Program/Erase cycles for Block A and B will be more effective. It is important to track the total number of block erases and restrict the number.
- 5. If error occurs during block erase, attempt to execute the clear status register command, then the block erase command at least three times until the erase error disappears.
- 6. Customers desiring Program/Erase failure rate information should contact their Renesas technical support representa-
- 7. The data hold time includes time that the power supply is off or the clock is not supplied.

Table 5.5 Flash Memory (Data flash Block A, Block B) Electrical Characteristics<sup>(4)</sup>

Symbol	Parameter	Measuring condition	S	Standard		
Суппост	raiailletei	Measuring condition	Min.	Тур.	Max	Unit
-	Program/Erase endurance <sup>(2)</sup>		10000(3)		_	times
_	Byte program time(program/erase endurance ≤1000 times)			50	400	μs
-	Byte program time(program/erase endurance >1000 times)			65	_	μs
_	Block erase time(program/erase endurance ≤1000 times)		_	0.2	9	s
-	Block erase time(program/erase endurance >1000 times)			0.3	_	s
td(SR-ES)	Time delay from Suspend Request until E	rase Suspend	_	_	8	ms
_	Erase Suspend Request Interval		10	_		ms
_	Program, Erase Voltage		2.7		5.5	V
_	Read Voltage		2.7	_	5.5	V
-	Program/Erase Temperature		-20(-40)(8)	_	85	°C
-	Data hold time <sup>(9)</sup>	Ambient temperature = 55 °C	20			year

- 1. Referenced to Vcc=AVcc=2.7 to 5.5V at Topr = -20°C to 85°C / -40°C to 85°C unless otherwise specified.
- 2. Definition of Program/Erase
  - The endurance of Program/Erase shows a time for each block.
  - If the program/erase number is "n" (n = 1000, 10000), "n" times erase can be performed for each block.
  - For example, if performing one-byte write to the distinct addresses on Block A of 2K-byte block 2048 times and then erasing that block, the number of Program/Erase cycles is one time.
  - However, performing multiple writes to the same address before an erase operation is prohibited (overwriting prohibited).
- 3. Numbers of Program/Erase cycles for which all electrical characteristics is guaranteed.
- 4. Table 5.5 applies for Block A or B when the Program/Erase cycles are more than 1000. The byte program time up to 1000 cycles are the same as that of the program area (see Table 5.4).
- 5. To reduce the number of Program/Erase cycles, a block erase should ideally be performed after writing in series as many distinct addresses (only one time each) as possible. If programming a set of 16 bytes, write up to 128 sets and then erase them one time. This will result in ideally reducing the number of Program/Erase cycles. Additionally, averaging the number of Program/Erase cycles for Block A and B will be more effective. It is important to track the total number of block erases and restrict the number.
- 6. If error occurs during block erase, attempt to execute the clear status register command, then the block erase command at least three times until the erase error disappears.
- 7. Customers desiring Program/Erase failure rate information should contact their Renesas technical support representa-
- 8. -40 °C for D version.
- 9. The data hold time includes time that the power supply is off or the clock is not supplied.

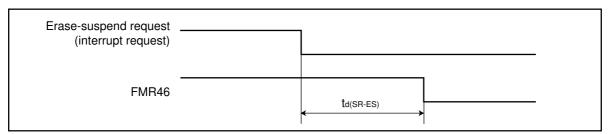


Figure 5.2 Time delay from Suspend Request until Erase Suspend

**Table 5.6 Voltage Detection Circuit Electrical Characteristics** 

Symbol	Parameter	Measuring condition	Standard		Ī	
Cymbol	i didiffetei	Wedsaring condition	Min.	Тур.	Max.	Unit
Vdet	Voltage detection level		3.3	3.8	4.3	V
	Voltage detection interrupt request generating time <sup>(2)</sup>			40		μs
	Voltage detection circuit self consumption current	VC27=1, VCC=5.0V		600		nA
td(E-A)	Waiting time until voltage detection circuit operation starts(3)				20	μs
Vccmin	Microcomputer operation voltage minimum value		2.7			V

#### NOTES:

- 1. The measuring condition is Vcc=AVcc=2.7V to 5.5V and Topr=-40°C to 85°C.
- 2. This shows the time until the voltage detection interrupt request is generated since the voltage passes Vdet.
- 3. This shows the required time until the voltage detection circuit operates when setting to "1" again after setting the VC27 bit in the VCR2 register to "0".

### Table 5.7 Reset Circuit Electrical Characteristics (When Using Hardware Reset 2<sup>(1, 3)</sup>)

Symbol	Parameter	Measuring condition	Standard			1.1
Cymbol	1 didilictor	Widdodning deficition	Min.	Тур.	Max.	Unit
Vpor2	Power-on reset valid voltage	–20°C ≤ Topr < 85°C	_	_	Vdet	V
tw(Vpor2- Vdet)	Supply voltage rising time when power-on reset is canceled <sup>(2)</sup>	-20°C ≤ Topr < 85°C, tw(por2) ≥ 0s <sup>(4)</sup>		_	100	ms

#### NOTES:

- 1. The voltage detection circuit which is embedded in a microcomputer is a factor to generate the hardware reset 2. Refer to 5.1.2 Hardware Reset 2 of Hardware Manual for details.
- 2. This condition is not applicable when using Vcc ≥ 1.0V.
- 3. When turning power on after the external power has been held below the valid voltage (Vpor1) for greater than 10 seconds, refer to Table 5.8 Reset Circuit Electrical Characteristics (When Not Using Hardware Reset 2).
- 4. tw(por2) is time to hold the external power below effective voltage (Vpor2).

### Table 5.8 Reset Circuit Electrical Characteristics (When Not Using Hardware Reset 2)

Symbol	Parameter	Measuring condition		Standard		Unit
Cymbol	randici	Wedsaming containen	Min.	Тур.	Max.	Uniii
Vpor1	Power-on reset valid voltage	-20°C ≤ Topr < 85°C	_	_	0.1	V
tW(Vpor1- Vdet)	Supply voltage rising time when power-on reset is canceled	$0^{\circ}C \le Topr \le 85^{\circ}C$ , $tw(por1) \ge 10s^{(2)}$		_	100	ms
tW(Vpor1- Vdet)	Supply voltage rising time when power-on reset is canceled	-20°C ≤ Topr < 0°C, tw(por1) ≥ $30$ s <sup>(2)</sup>	-	_	100	ms
tW(Vpor1- Vdet)	Supply voltage rising time when power-on reset is canceled	$-20^{\circ}\text{C} \le \text{Topr} < 0^{\circ}\text{C}, \text{ tw(por1)} \ge 10\text{s}^{(2)}$	1	_	1	ms
tW(Vpor1- Vdet)	Supply voltage rising time when power-on reset is canceled	$0^{\circ}C \le Topr \le 85^{\circ}C$ , $tw(por1) \ge 1s^{(2)}$	1	_	0.5	ms

- When not using hardware reset 2, use with Vcc ≥ 2.7V.
- 2. tw(por1) is time to hold the external power below effective voltage (Vpor1).

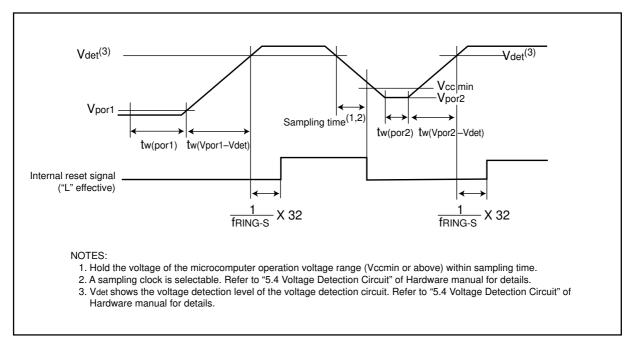


Figure 5.3 Reset Circuit Electrical Characteristics

### Table 5.9 High-speed On-Chip Oscillator Circuit Electrical Characteristics

Symbol	Parameter	Measuring condition		Standard		I India
Cymbol	i didilicio	Wiededning Condition	Min.	Тур.	Max.	Unit
_	High-speed on-chip oscillator frequency 1 / $\{td(HRoffset)+td(HR)\}$ when the reset is released	VCC=5.0V, Topr=25 °C Set "4016" in the HR1 register	_	8	=	MHz
td(HRoffset)	Settable high-speed on-chip oscillator minimum period	VCC=5.0V, Topr=25 °C Set "0016" in the HR1 register		61	_	ns
td(HR)	High-speed on-chip oscillator period adjusted unit	Differences when setting "0116" and "0016" in the HR register	-	1	_	ns
_	High-speed on-chip oscillator frequency temperature dependence(1)	Frequency fluctuation in temperature range of -10 °C to 50 °C	_	±5	_	%
_	High-speed on-chip oscillator frequency temperature dependence(2)	Frequency fluctuation in temperature range of -40 °C to 85 °C	_	±10	_	%

### NOTES:

### **Table 5.10 Power Circuit Timing Characteristics**

Symbol	Parameter	Measuring condition		Standard		
	i didilietei	Wicasaring condition	Min.	Тур.	Max.	Unit
td(P-R)	Time for internal power supply stabilization during powering-on(2)		1		2000	μs
td(R-S)	STOP release time <sup>(</sup> 3)				150	μs

#### NOTES:

- 1. The measuring condition is Vcc=AVcc=2.7 to 5.5 V and Topr=25 °C.
- 2. This shows the wait time until the internal power supply generating circuit is stabilized during power-on.
- 3. This shows the time until BCLK starts from the interrupt acknowledgement to cancel stop mode.

### Table 5.11 Electrical Characteristics (1) [Vcc=5V]

Symbol	Par	rameter	Measuring	condition		Standard		Link
Symbol	ı aı	ameter	Wicasainig	goonamon	Min.	Тур.	Max.	Unit
	"H" output voltage	Except Xouт	IOH=-5mA		Vcc-2.0	-	Vcc	V
Vон			Іон=-200μА		Vcc-0.3	_	Vcc	V
		Хоит	Drive capacity HIGH	IOH=-1 mA	Vcc-2.0	_	Vcc	V
			Drive capacity LOW	Іон=-500μА	Vcc-2.0	1	Vcc	V
	"L" output voltage	Except P10 to P17, XouT	IoL= 5 mA		_	_	2.0	V
Vol			IoL= 200 μA		_	_	0.45	٧
		P10 to P17	Drive capacity HIGH	IoL= 15 mA	_		2.0	٧
			Drive capacity LOW	IoL= 5 mA	_	_	2.0	٧
			Drive capacity LOW	IoL= 200 μA	_		0.45	٧
		Хоит	Drive capacity HIGH	IoL= 1 mA	_	_	2.0	٧
			Drive capacity LOW	Ιοι=500 μΑ	_		2.0	V
VT+-VT-	Hysteresis	INT0, INT1, INT2, INT3, KI0, KI1, KI2, KI3, CNTRo, CNTR1, TCIN, RxD0, RxD1, P45			0.2	_	1.0	V
		RESET			0.2	1	2.2	٧
lін	"H" input current		VI=5V		_	_	5.0	μА
lıL	"L" input current	·	VI=0V		_	_	-5.0	μΑ
RPULLUP	Pull-up resistance		VI=0V		30	50	167	kΩ
RfXIN	Feedback resistance	XIN			_	1.0	_	МΩ
fRING-S	Low-speed on-chip oscillator frequer	псу			40	125	250	kHz
VRAM	RAM retention voltage		At stop mode		2.0	_	_	V



<sup>1.</sup> The measuring condition is Vcc=AVcc=5.0 V and Topr=25 °C.

<sup>1.</sup> Referenced to Vcc = AVcc = 4.2 to 5.5V at Topr = -20 to 85 °C / -40 to 85 °C, f(XIN)=20MHz unless otherwise specified.

Table 5.12 Electrical Characteristics (2) [Vcc=5V]

Symbol	Para	ameter	Me	asuring condition		Standard		11.3
Cyrribor	Falc	ameter	IVIE	23ding Condition	Min.	Тур.	Max.	Unit
			High-speed mode	XIN=20 MHz (square wave)   High-speed on-chip oscillator off  Low-speed on-chip oscillator on=125 kHz   No division	_	9	15	mA
				XIN=16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on=125 kHz No division	_	8	14	mA
				XIN=10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on=125 kHz No division	_	5		mA
			Medium-speed mode	XIN=20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on=125 kHz Division by 8		4		mA
Icc	Power supply current (Vcc=3.3 to 5.5V)			X <sub>IN</sub> =16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on=125 kHz Division by 8	_	3	_	mA
	In single-chip mode, the output pins are open and other pins are Vss			Xn=10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on=125 kHz Division by 8	_	2		mA
	High-speed on-chip oscillator mode	Main clock off High-speed on-chip oscillator on=8 MHz Low-speed on-chip oscillator on=125 kHz No division	_	4	8	mA		
				Main clock off High-speed on-chip oscillator on=8 MHz Low-speed on-chip oscillator on=125 kHz Division by 8	_	1.5		mA
			Low-speed on-chip oscillator mode	Main clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on=125 kHz Division by 8	_	470	900	μА
			Wait mode	Main clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on=125 kHz When a WAIT instruction is executed <sup>(1)</sup> Peripheral clock operation VC27="0"	_	40	80	μА
			Wait mode	Main clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on=125 kHz When a WAIT instruction is executed(1) Peripheral clock off VC27="0"	_	38	76	μА
			Stop mode	Main clock off, Topr=-25 °C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10="1" Peripheral clock off VC27="0"	_	0.8	3.0	μА



NOTES:
1. Timer Y is operated with timer mode.
2. Referenced to Vcc = AVcc = 4.2 to 5.5V at Topr = -20 to 85 °C / -40 to 85 °C, f(XIN)=20MHz unless otherwise specified.

### Timing requirements [Vcc=5V] (Unless otherwise noted: Vcc = 5V, Vss = 0V at Topr = 25 °C)

Table 5.13 XIN input

Symbol	Parameter	Stan	dard	Unit
		Min.	Max.	
tc(XIN)	XIN input cycle time	50	_	ns
twH(XIN)	XIN input HIGH pulse width	25	_	ns
twL(XIN)	XIN input LOW pulse width	25	_	ns

### Table 5.14 CNTR0 input, CNTR1 input, INT2 input

Symbol	Parameter	Stan	dard	Unit
		Min.	Max.	
tC(CNTR0)	CNTR0 input cycle time	100	_	ns
tWH(CNTR0)	CNTR0 input HIGH pulse width	40	_	ns
tWL(CNTR0)	CNTR0 input LOW pulse width	40	_	ns

### Table 5.15 TCIN input, INT3 input

Symbol	Parameter	Stan	dard	Unit
		Min.	Max.	
tc(TCIN)	TCIN input cycle time	400 <sup>(1)</sup>	_	ns
tWH(TCIN)	TCIN input HIGH pulse width	200 <sup>(2)</sup>	_	ns
tWL(TCIN)	TCIN input LOW pulse width	200 <sup>(2)</sup>	_	ns

### NOTES:

- 1. When using the Timer C input capture mode, adjust the cycle time above ( 1/ Timer C count source frequency x 3).
- 2. When using the Timer C input capture mode, adjust the pulse width above ( 1/ Timer C count source frequency x 1.5).

### Table 5.5 Serial Interface

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tc(ck)	CLKi input cycle time	200	_	ns
tW(CKH)	CLKi input HIGH pulse width	100	_	ns
tW(CKL)	CLKi input LOW pulse width	100	_	ns
td(C-Q)	TxDi output delay time	_	80	ns
th(C-Q)	TxDi hold time	0	_	ns
tsu(D-C)	RxDi input setup time	35	_	ns
th(C-D)	RxDi input hold time	90	_	ns

### Table 5.17 External interrupt INTO input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tw(INH)	INTO input HIGH pulse width	250 <sup>(1)</sup>	_	ns
tW(INL)	INTO input LOW pulse width	250 <sup>(2)</sup>	_	ns

- 1. When selecting the digital filter by the  $\overline{\text{INT0}}$  input filter select bit, use the  $\overline{\text{INT0}}$  input HIGH pulse width to the greater value, either (1/digital filter clock frequency x 3) or the minimum value of standard.
- 2. When selecting the digital filter by the  $\overline{\text{INT0}}$  input filter select bit, use the  $\overline{\text{INT0}}$  input LOW pusle width to the greater value, either (1/ digital filter clock frequency x 3) or the minimum value of standard.

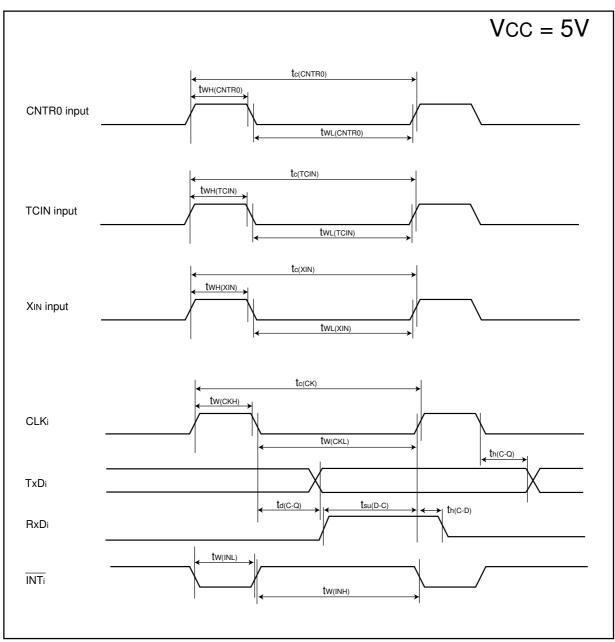


Figure 5.4 Vcc=5V timing diagram

**Table 5.18 Electrical Characteristics (3)** [Vcc=3V]

Symbol	Parameter		Measuring condition			Standard		
					Min.	Тур.	Max.	Unit
	"H" output voltage	Except Xout	IOH=-1mA		Vcc-0.5	_	Vcc	V
Vон		Хоит	Drive capacity HIGH	IOH=-0.1 mA	Vcc-0.5	_	Vcc	V
			Drive capacity LOW	Іон=-50 μА	Vcc-0.5	_	Vcc	V
	"L" output voltage	Except P10 to P17, XouT	IoL= 1 mA		_	_	0.5	٧
VoL		P10 to P17	Drive capacity HIGH	IoL= 2 mA		_	0.5	V
			Drive capacity LOW	IoL= 1 mA	_	_	0.5	V
		Хоит	Drive capacity HIGH	IOL= 0.1 mA		-	0.5	V
			Drive capacity LOW	IoL=50 μA	_	_	0.5	V
VT+-VT-	Hysteresis	INTo, INT1, INT2, INT3, KI0, KI1, KI2, KI3, CNTR0, CNTR1, TCIN, RxD0, RxD1, P45			0.2	_	0.8	V
		RESET			0.2	_	1.8	٧
lін	"H" input current		VI=3V		_	_	4.0	μΑ
lıL	"L" input current		VI=0V		_	_	-4.0	μΑ
RPULLUP	Pull-up resistance		VI=0V		66	160	500	kΩ
RfXIN	Feedback resistance	XIN			_	3.0	_	МΩ
fRING-S	Low-speed on-chip oscillator frequency				40	125	250	kHz
VRAM	RAM retention voltage		At stop mode		2.0	_	_	V

NOTES:

1. Referenced to Vcc = AVcc = 2.7 to 3.3V at Topr = -20 to 85 °C / -40 to 85 °C, f(XIN)=10MHz unless otherwise specified.